

advanced

60 V

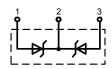
0.63 V

Schottky

High Performance Schottky Diode Low Loss and Soft Recovery Common Cathode

Part number (Marking on product)

DSB 20 C 60PN



Features / Advantages:

- Very low Vf
- Extremely low switching losses
- Low Irm-values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters



Package:

 $V_{RRM} =$

 $I_{FAV} = 2x \cdot 10 A$

TO-220FPAB

- Industry standard outline
- Plastic overmolded tab for electrical isolation
- Epoxy meets UL 94V-0
- RoHŚ compliant

Ratings

| Symbol | Definition | Conditions | | min. | typ. | max. | Unit |
|-------------------|--|---|---------------------------------|------|------|------|-----------|
| V _{RRM} | max. repetitive reverse voltage | | T _{VJ} = 25 °C | | | 60 | V |
| I _R | reverse current | V _R = 60 V | T _{VJ} = 25 °C | | | 6 | mA |
| | | $V_R = 60 V$ | $T_{VJ} = 100 ^{\circ}C$ | | | 30 | mA |
| V _F | forward voltage | I _F = 10 A | T _{VJ} = 25°C | | | 0.73 | V |
| | | $I_F = 20 A$ | | | | 1.11 | V |
| | | $I_F = 10 A$ | T - 405°C | | | 0.63 | V |
| | | $I_F = 20 A$ | $T_{VJ} = 125 ^{\circ}\text{C}$ | | | 0.87 | V |
| I _{FAV} | average forward current | rectangular, d = 0.5 | $T_{\rm c}$ = 115 °C | | | 10 | Α |
| V _{F0} | threshold voltage for power loss calculation only | | | | 0.46 | V | |
| | slope resistance \(\int \text{ for power loss} \) | sulation only | | | | 14.5 | $m\Omega$ |
| R _{thJC} | thermal resistance junction to case | | | | | 4.50 | K/W |
| T _{vJ} | virtual junction temperature | | -55 | | 150 | °C | |
| P _{tot} | total power dissipation $T_c = 25 ^{\circ}C$ | | T _C = 25 °C | | | 30 | W |
| I _{FSM} | max. forward surge current | $t_p = 10 \text{ ms } (50 \text{ Hz}), \text{ sine}$ | T _{VJ} = 45 °C | | | 100 | А |
| C¹ | junction capacitance | $V_R = V; f = 1 MHz$ | $T_{VJ} = 25 ^{\circ}C$ | | | | pF |
| E _{AS} | non-repetitive avalanche energy | $I_{AS} = A; L = 100 \mu\text{H}$ | T _{vJ} = 25 °C | | | tbd | mJ |
| I _{AR} | repetitive avalanche current | $V_A = 1.5 \cdot V_R \text{ typ.; } f = 10 \text{ kHz}$ | | | | tbd | Α |

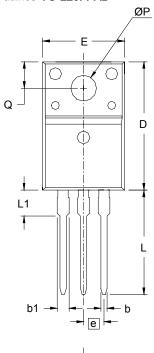


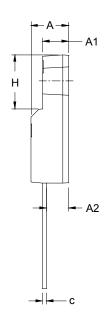
advanced

| Symbol | Definition | Conditions | min. | typ. | max. | Unit |
|-------------------|-------------------------------------|------------|------|------|------|------|
| I _{RMS} | RMS current | per pin* | | | 35 | Α |
| R _{thCH} | thermal resistance case to heatsink | | | 0.50 | | K/W |
| M _D | mounting torque | | 0.4 | | 0.6 | Nm |
| F _c | mounting force with clip | | 20 | | 60 | N |
| T _{stg} | storage temperature | | -55 | | 150 | °C |
| Weight | | | | 2 | | g |

^{*} Irms is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip. In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

Outlines TO-220FPAB





| SYM | INCHES | | MILLIMETERS | | |
|------|---------|------|-------------|-------|--|
| 2114 | MIN | MAX | MIN | MAX | |
| Α | .177 | .193 | 4.50 | 4.90 | |
| A1 | .092 | .108 | 2.34 | 2.74 | |
| A2 | .101 | .117 | 2.56 | 2.96 | |
| b | .028 | .035 | 0.70 | 0.90 | |
| b1 | .050 | .058 | 1.27 | 1.47 | |
| С | .018 | .024 | 0.45 | 0.60 | |
| D | .617 | .633 | 15.67 | 16.07 | |
| E | .392 | .408 | 9.96 | 10.36 | |
| е | 100 BSC | | 2.54 BSC | | |
| Н | .255 | .271 | 6.48 | 6.88 | |
| L | .499 | .523 | 12.68 | 13.28 | |
| L1 | .119 | .135 | 3.03 | 3.43 | |
| ØP | .121 | .129 | 3.08 | 3.28 | |
| Q | .126 | .134 | 3.20 | 3.40 | |